

# MDP11N60

## N-Channel MOSFET 600V, 11A, 0.55Ω

### General Description

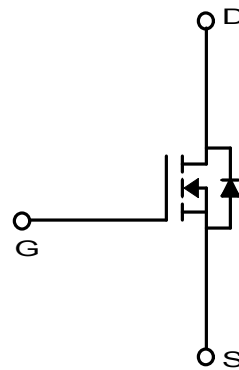
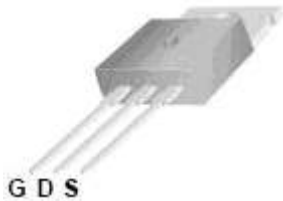
MDP11N60 is suitable device for SMPS, high Speed switching and general purpose applications.

### Features

- $V_{DS} = 600V$
- $I_D = 11A$  @  $V_{GS} = 10V$
- $R_{DS(ON)} \leq 0.55\Omega$  @  $V_{GS} = 10V$

### Applications

- Power Supply
- PFC
- High Current, High Speed Switching



### Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Drain-Source Voltage	$V_{DSS}$	600	V	
Gate-Source Voltage	$V_{GSS}$	±30	V	
Continuous Drain Current (※)	$I_D$	$T_C=25^\circ C$	11	A
		$T_C=100^\circ C$	6.9	A
Pulsed Drain Current <sup>(1)</sup>	$I_{DM}$	44	A	
Power Dissipation	$P_D$	$T_C=25^\circ C$	182	W
		Derate above 25 °C	1.45	W/°C
Peak Diode Recovery $dv/dt$ <sup>(3)</sup>	$Dv/dt$	4.5	V/ns	
Single Pulse Avalanche Energy <sup>(4)</sup>	$E_{AS}$	720	mJ	
Junction and Storage Temperature Range	$T_J, T_{stg}$	-55~150	°C	

※  $I_D$  limited by maximum junction temperature

### Thermal Characteristics

Characteristics	Symbol	Rating	Unit
Thermal Resistance, Junction-to-Ambient <sup>(1)</sup>	$R_{\theta JA}$	62.5	°C/W
Thermal Resistance, Junction-to-Case <sup>(1)</sup>	$R_{\theta JC}$	0.69	

## Ordering Information

Part Number	Temp. Range	Package	Packing	RoHS Status
MDP11N60	-55~150°C	TO-220	Tube	Halogen Free

## Electrical Characteristics (Ta =25°C)

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$I_D = 250\mu A, V_{GS} = 0V$	600	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	3.0	-	5.0	
Drain Cut-Off Current	$I_{DSS}$	$V_{DS} = 600V, V_{GS} = 0V$	-	-	1	$\mu A$
Gate Leakage Current	$I_{GSS}$	$V_{GS} = \pm 30V, V_{DS} = 0V$	-	-	100	nA
Drain-Source ON Resistance	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 5.5A$	-	0.45	0.55	$\Omega$
Forward Transconductance	$g_{fs}$	$V_{DS} = 30V, I_D = 5.5A$	-	13	-	S
<b>Dynamic Characteristics</b>						
Total Gate Charge	$Q_g$	$V_{DS} = 480V, I_D = 11A, V_{GS} = 10V^{(3)}$	-	38.4	-	nC
Gate-Source Charge	$Q_{gs}$		-	11.2	-	
Gate-Drain Charge	$Q_{gd}$		-	14	-	
Input Capacitance	$C_{iss}$	$V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz$	-	1700		pF
Reverse Transfer Capacitance	$C_{rss}$		-	6.2		
Output Capacitance	$C_{oss}$		-	184		
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = 10V, V_{DS} = 300V, I_D = 11A, R_G = 25\Omega^{(3)}$	-	38		ns
Rise Time	$t_r$		-	50		
Turn-Off Delay Time	$t_{d(off)}$		-	76		
Fall Time	$t_f$		-	33		
<b>Drain-Source Body Diode Characteristics</b>						
Maximum Continuous Drain to Source Diode Forward Current	$I_S$		-	11	-	A
Source-Drain Diode Forward Voltage	$V_{SD}$	$I_S = 11A, V_{GS} = 0V$	-		1.4	V
Body Diode Reverse Recovery Time	$t_{rr}$	$I_F = 11A, di/dt = 100A/\mu s^{(3)}$	-	430		ns
Body Diode Reverse Recovery Charge	$Q_{rr}$		-	4.0		$\mu C$

Note :

1. Pulse width is based on  $R_{\theta JC}$  &  $R_{\theta JA}$  and the maximum allowed junction temperature of 150°C.
2. Pulse test: pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ , pulse width limited by junction temperature  $T_{J(MAX)} = 150^\circ C$ .
3.  $I_{SD} \leq 11.0A$ ,  $di/dt \leq 200A/\mu s$ ,  $V_{DD} = 50V$ ,  $R_G = 25\Omega$ , Starting  $T_J = 25^\circ C$
4.  $L = 10.9mH$ ,  $I_{AS} = 11A$ ,  $V_{DD} = 50V$ ,  $R_G = 25\Omega$ , Starting  $T_J = 25^\circ C$

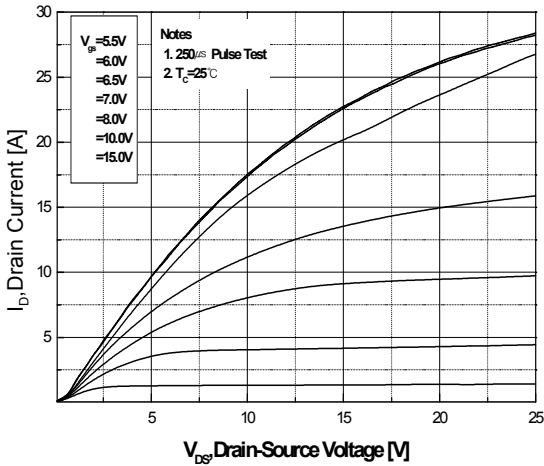


Fig.1 On-Region Characteristics

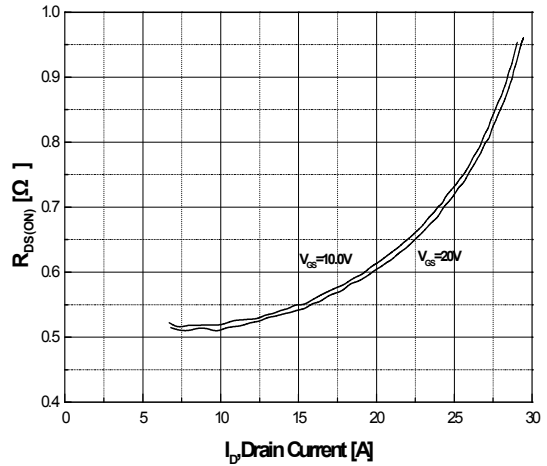


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

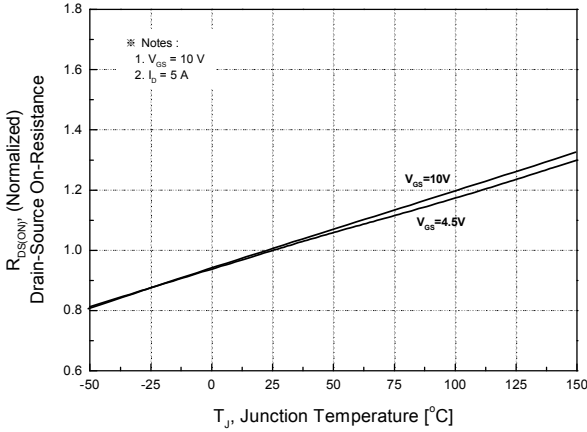


Fig.3 On-Resistance Variation with Temperature

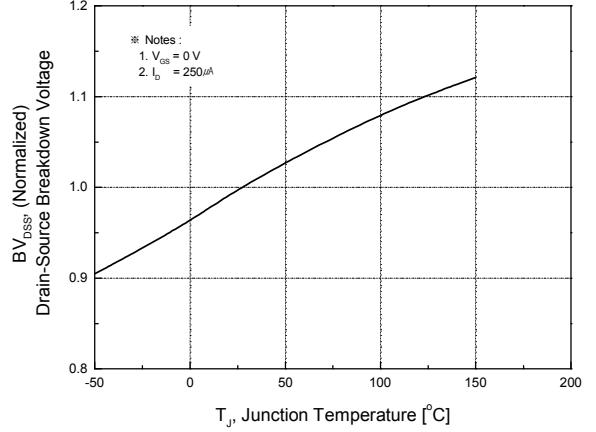


Fig.4 Breakdown Voltage Variation vs. Temperature

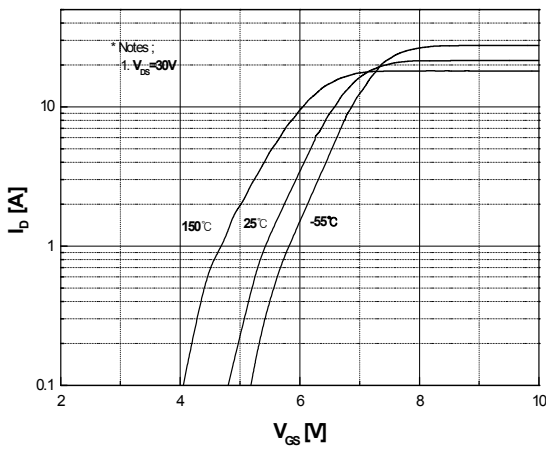


Fig.5 Transfer Characteristics

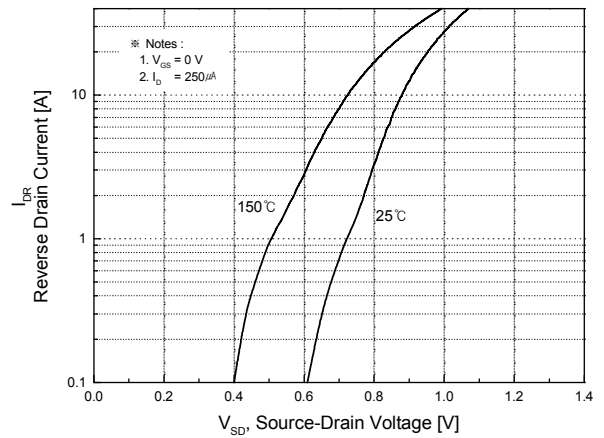


Fig.6 Body Diode Forward Voltage Variation with Source Current and Temperature

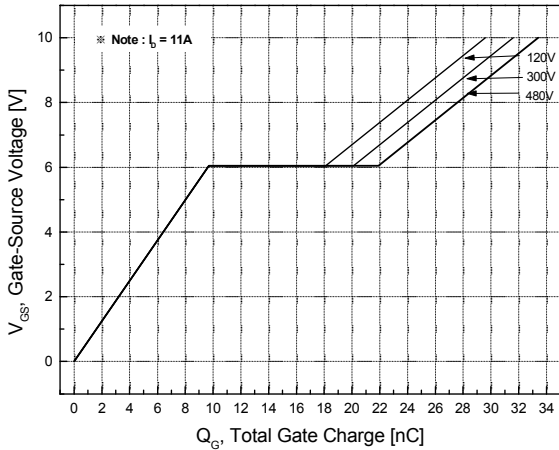


Fig.7 Gate Charge Characteristics

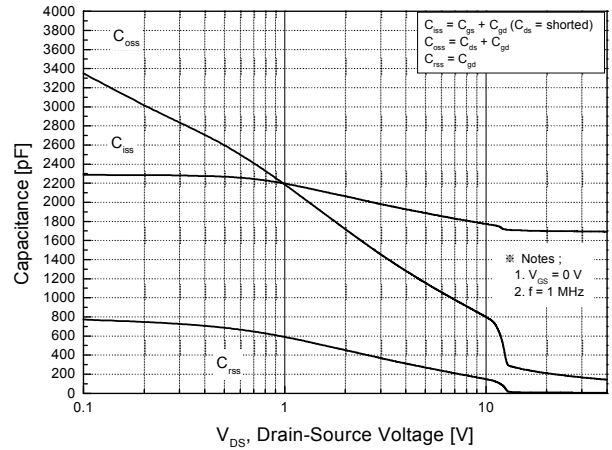


Fig.8 Capacitance Characteristics

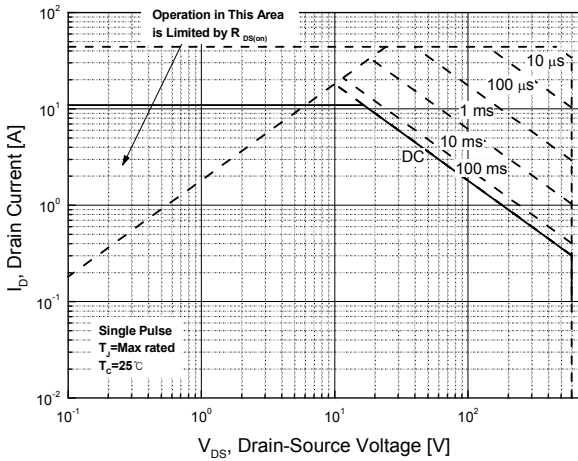


Fig.9 Maximum Safe Operating Area

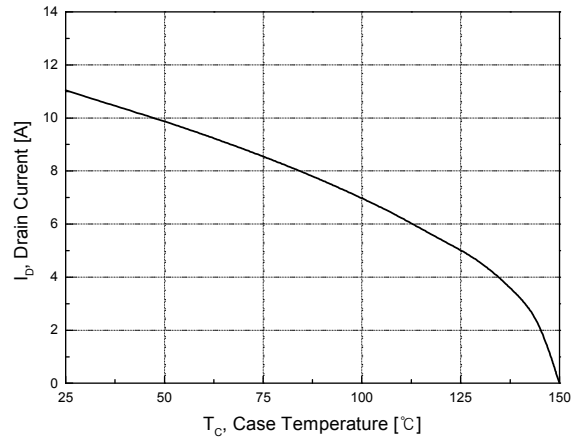


Fig.10 Maximum Drain Current vs. Case Temperature

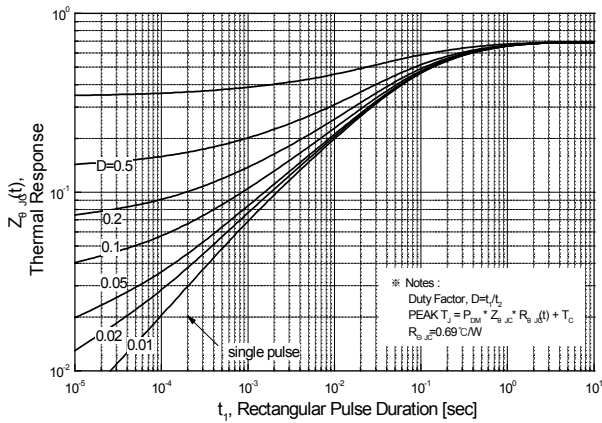


Fig.11 Transient Thermal Response Curve

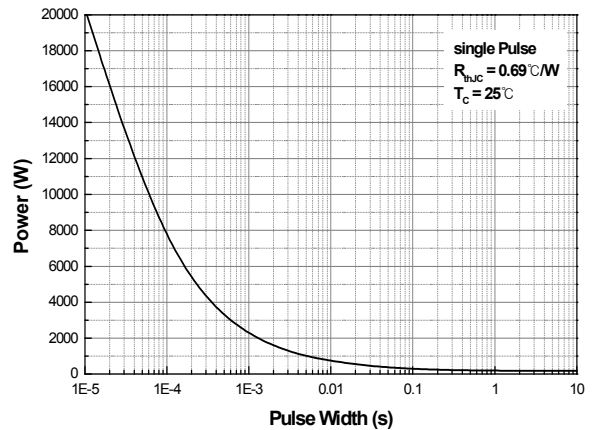


Fig.12 Single Pulse Maximum Power Dissipation

Physical Dimensions

MDP11N60 N-channel MOSFET 600V

TO-220

